



Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED







HMC551LP4 / 551LP4E

GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz



Typical Applications

The HMC551LP4 / HMC551LP4E is ideal for Wireless Infrastructure Applications:

- Cellular / 3G Infrastructure
- Base Stations & Repeaters
- GSM, CDMA & W-CDMA
- PLMR & ISM

Features

Input IP3: +27 dBm

Low Input LO Drive: -4 to +4 dBm

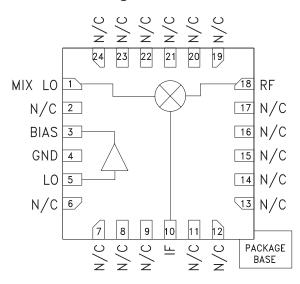
LO to RF Isolation: 27 dB

Low Conversion Loss: 8 dB

Single Supply: +5V @ 62 mA

24 Lead 4x4mm QFN Package: 9 mm²

Functional Diagram



General Description

The HMC551LP4 & HMC551LP4E are high linearity, double balanced Converter ICs that operate from 0.8 to 1.2 GHz and deliver a +27 dBm input third order intercept point. The LO amplifier output and high dynamic range mixer input are positioned so that an external LO filter can be placed in series between them. The converter provides 27 dB of LO to RF isolation and is ideal for upconverter and down-converter applications. The IC operates from a single +5V supply consuming 62 mA of current and accepts a LO drive level of -4 to +4 dBm. The design requires no external baluns and supports IF frequencies between DC and 300 MHz. The HMC551LP4(E) are pin for pin compatible with the HMC552LP4(E) which operate from 1.6 to 3.0 GHz.

Electrical Specifications, $T_A = +25^{\circ}$ C, LO = 0 dBm, Vcc = +5V, R1 = 18 Ohms, IF = 100 MHz*

Parameter	Min.	Тур.	Max.	Units
Frequency Range, RF, LO		0.8 - 1.2		GHz
Frequency Range, IF		DC - 300		MHz
Conversion Loss		8	10	dB
Noise Figure (SSB)		8		dB
LO to RF Isolation	20	27		dB
LO to IF Isolation	12	17		dB
IP3 (Input)		27		dBm
1 dB Compression (Input)		17		dBm
LO Drive Input Level (Typical)	-4 to +4 dBm		dBm	
Supply Current (Icc)		62		mA

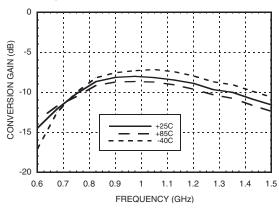
^{*}Unless otherwise noted, all measurements performed as a downconverter configured as shown in application circuit.



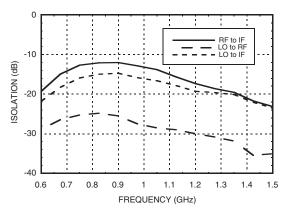


GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

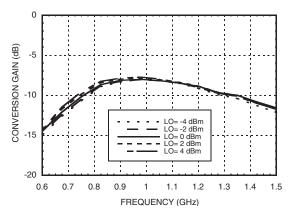
Conversion Gain vs. Temperature @ LO = 0 dBm



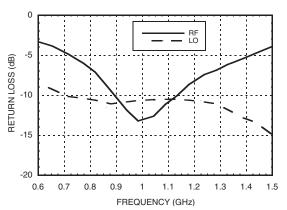
Isolation @ LO = 0 dBm



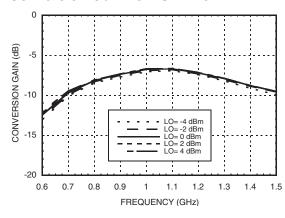
Conversion Gain vs. LO Drive



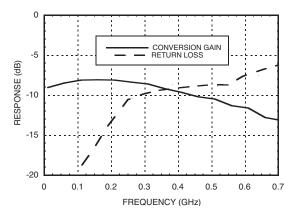
Return Loss @ LO = 0 dBm



Upconverter Performance Conversion Gain vs. LO Drive



IF Bandwidth @ LO = 0 dBm



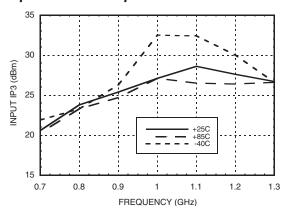
10



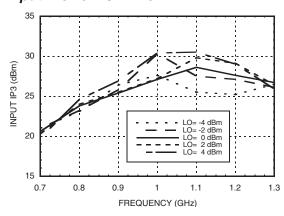


GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

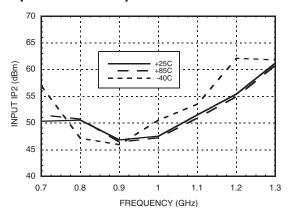
Input IP3 vs. Temperature @ LO = 0 dBm



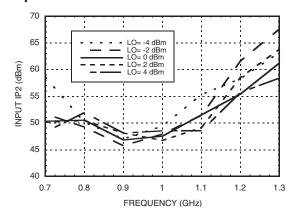
Input IP3 vs. LO Drive



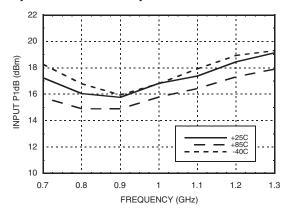
Input IP2 vs. Temperature @ LO = 0 dBm



Input IP2 vs. LO Drive



Input P1dB vs. Temperature @ LO = 0 dBm





HMC551LP4 / 551LP4E

GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz



MxN Spurious @ IF Port

	nLO				
mRF	0	1	2	3	4
0	xx	-3	33	21	21
1	4	0	13	35	45
2	81	68	63	60	74
3	87	102	85	74	71
4	106	96	102	103	103

RF Freq. = 0.9 GHz @ -10 dBmLO Freq. = 0.8 GHz @ 0 dBm

All values in dBc relative to the IF power level.

Harmonics of LO

	nLO Spur @ RF Port			
LO Freq. (GHz)	1	2	3	4
0.7	24	21	34	40
0.8	25	22	34	49
0.9	27	23	38	57
1.0	28	23	43	45
1.1	29	24	43	54
1.2	30	25	37	61

LO = 0 dBm

All values in dBc below input LO level measured at RF port.

Typical Supply Current

Vcc	Icc (mA)
+5.0	62 mA



HMC551LP4 / 551LP4E

GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

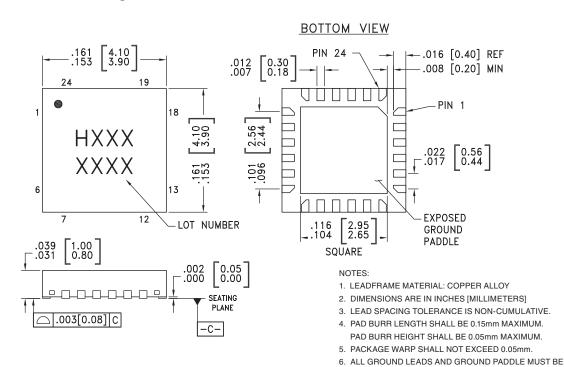


Absolute Maximum Ratings

RF / IF Input (Vcc= +5V)	+31 dBm
LO Drive (Vcc= +5V)	+10 dBm
BIAS	+7 Vdc
Junction Temperature	150°C
Continuous Pdiss (T = 85°C) (derate 9.5 mW/°C above 85°C)	0.6 W
Thermal Resistance (junction to ground paddle)	105.6 °C/W
Storage Temperature	-65 to +150°C
Operating Temperature	-40 to +85°C
ESD Sensitivity (HBM)	Class 1C



Outline Drawing



Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC551LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H551 XXXX
HMC551LP4E RoHS-compliant Low Stress Injection Molded Plastic		100% matte Sn	MSL1 [2]	H551 XXXX

SOLDERED TO PCB RF GROUND.

LAND PATTERN.

7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX







GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

Pin Descriptions

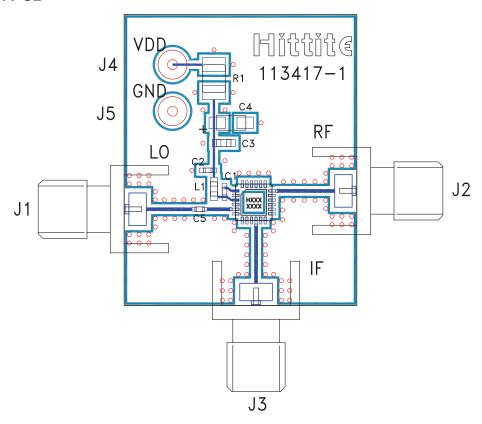
Pin Number	Function	Description	Interface Schematic
1	MIX LO	This pin is DC coupled and matched to 50 Ohms. An off chip DC blocking capacitor is required.	MIX LOO
2, 6 - 9, 11 - 17, 19 - 24	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
3	BIAS	Power supply for the LO amplifier Bias resistor is required . Three external bypass capacitors are recommended for optimum performance, as illustrated in the application circuit.	BIASO
4	GND	Backside of package has exposed metal ground paddle that must also be connected to ground.	GND
5	LO	This pin is DC coupled and matched to 50 Ohms from 0.8 to 1.2 GHz. An off chip DC blocking capacitor is required.	
10	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 18 mA of current or die non-function and possible die failure will result.	IFO THE STATE OF T
18	RF	This pin is DC coupled and matched to 50 Ohms.	RF O————————————————————————————————————





GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

Evaluation PCB



List of Materials for Evaluation PCB 113419 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4, J5	DC Pin
C1, C2, C5	100 pF Chip Capacitor, 0402 Pkg.
C3	1000 pF Chip Capacitor, 0603 Pkg.
C4	2.2 µF Capacitor, Tantalum
L1	56 nH Chip Inductor, 0603 Pkg.
R1	18 Ohm Resistor, 1210 1/8 watt Pkg.
U1	HMC551LP4 / HMC551LP4E
PCB [2]	113417 Evaluation Board

^[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

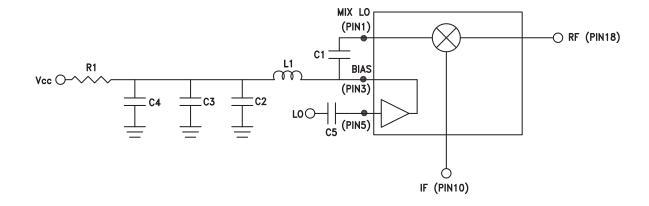
The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

Application Circuit



Recommended Components Values (IF = DC - 300 MHz)		
C3	1000 pF	
C4	2.2 μF	
C1, C2, C5	100 pF	
L1 56 nH		
R1 18 Ohms		

Note:

Select R1 to achieve Icc by using equation below, R1 \geq 18 Ohms.

Icc = (Vs - 3.8)/R1

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

HMC551LP4E HMC551LP4ETR HMC551LP4